

General Description

The MDD5N50F uses advanced Magnachip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality.

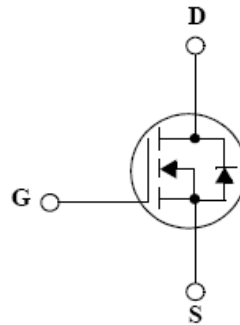
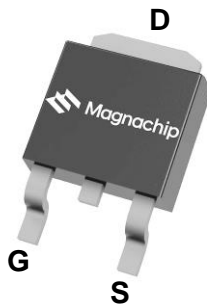
MDD5N50F is suitable device for Power Supply, PFC and general purpose applications.

Features

- $V_{DS} = 500V$
- $I_D = 4.2A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} \leq 1.5\Omega$ @ $V_{GS} = 10V$

Applications

- Power Supply
- PFC
- Ballast



Absolute Maximum Ratings ($T_a = 25^\circ C$)

Characteristics		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current	$T_C=25^\circ C$	I_D	4.2	A
	$T_C=100^\circ C$		2.6	A
Pulsed Drain Current ⁽¹⁾		I_{DM}	16.8	A
Power Dissipation	$T_C=25^\circ C$	P_D	70	W
	Derate above 25 °C		0.56	W/°C
Peak Diode Recovery dv/dt ⁽³⁾		Dv/dt	4.5	V/ns
Single Pulse Avalanche Energy ⁽⁴⁾		E_{AS}	230	mJ
Junction and Storage Temperature Range		T_J, T_{stg}	-55~150	°C

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	$R_{\theta JA}$	110	°C/W
Thermal Resistance, Junction-to-Case ⁽¹⁾	$R_{\theta JC}$	1.8	

Ordering Information

Part Number	Marking	Temp. Range	Package	Packing	RoHS Status
MDD5N50FRH	MDD5N50F	-55~150°C	TO-252(DPAK)	Reel and Tape	Halogen Free

Electrical Characteristics (Ta =25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250\mu A, V_{GS} = 0V$	500	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5	-	4.5	V
Drain Cut-Off Current	I_{DSS}	$V_{DS} = 500V, V_{GS} = 0V$	-	-	10	μA
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	100	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 2.1A$	-	1.25	1.55	Ω
Forward Transconductance	g_{fs}	$V_{DS} = 30V, I_D = 2.1A$	-	5	-	S
Dynamic Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 400V, I_D = 4.2A, V_{GS} = 10V^{(3)}$	-	12.2	-	nC
Gate-Source Charge	Q_{gs}		-	3.6	-	
Gate-Drain Charge	Q_{gd}		-	4.7	-	
Input Capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$	-	530	-	pF
Reverse Transfer Capacitance	C_{riss}		-	3	-	
Output Capacitance	C_{oss}		-	65	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DS} = 250V, I_D = 4.2A, R_G = 25\Omega^{(3)}$	-	12	-	Ns
Rise Time	t_r		-	24	-	
Turn-Off Delay Time	$t_{d(off)}$		-	24	-	
Fall Time	t_f		-	22	-	
Drain-Source Body Diode Characteristics						
Maximum Continuous Drain to Source Diode Forward Current	I_S		-	4.2	-	A
Source-Drain Diode Forward Voltage	V_{SD}	$I_S = 4.2A, V_{GS} = 0V$	-	-	1.4	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 4.2A, di/dt = 100A/\mu s^{(3)}$	-	105	-	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	0.2	-	μC

Note :

1. Pulse width is based on R θ_{JC} & R θ_{JA} and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ C$.
3. $I_{SD} \leq 4.2A$, $di/dt \leq 200A/\mu s$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$
4. $L = 16.5mH$, $I_{AS} = 4.2A$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^\circ C$

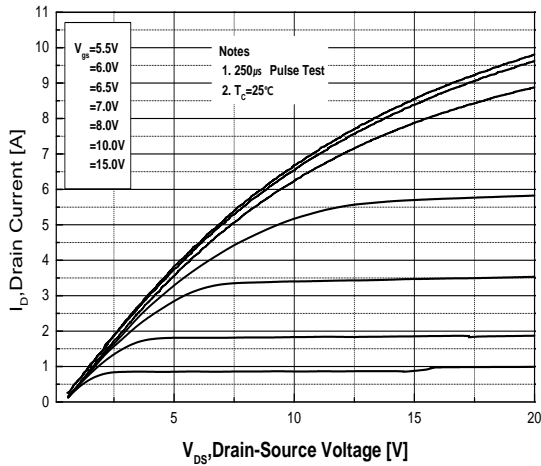


Fig.1 On-Region Characteristics

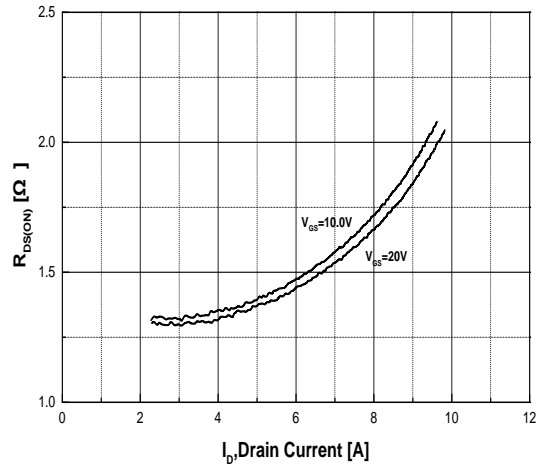


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

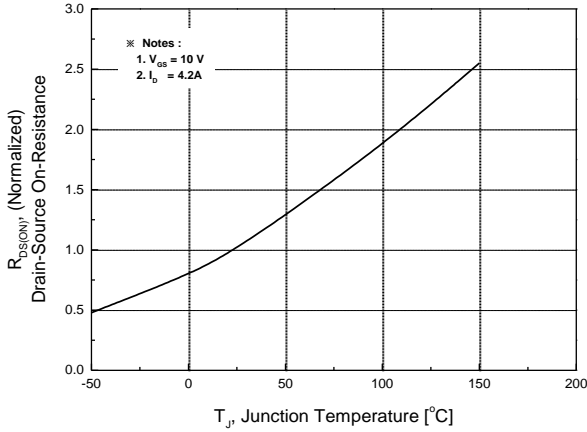


Fig.3 On-Resistance Variation with Temperature

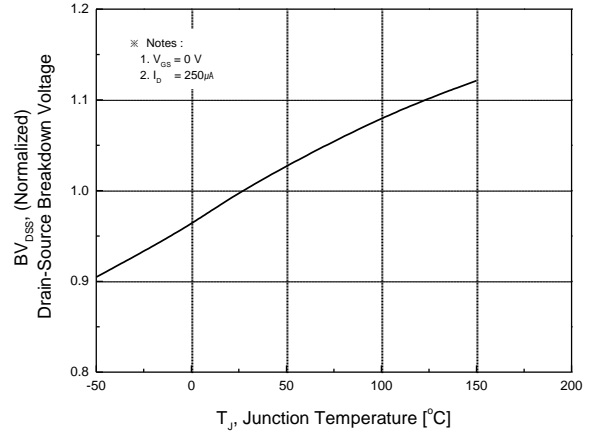


Fig.4 Breakdown Voltage Variation vs. Temperature

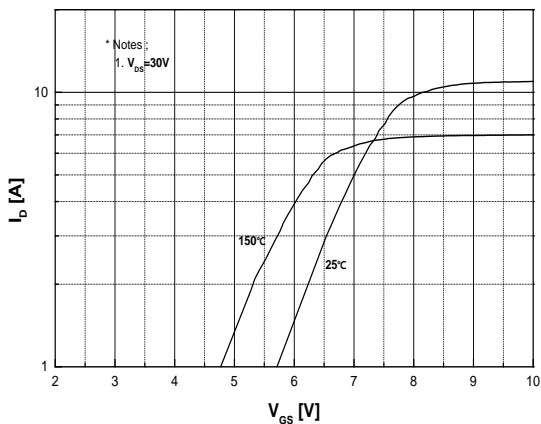


Fig.5 Transfer Characteristics

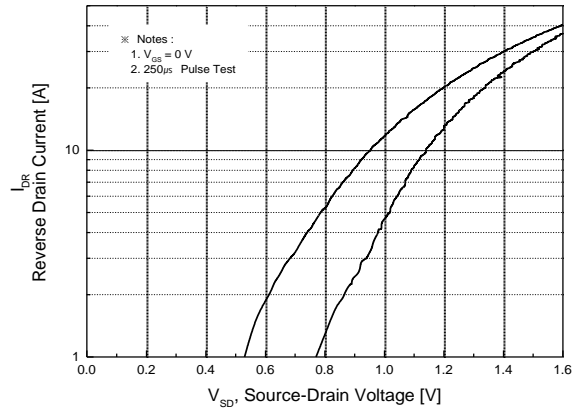
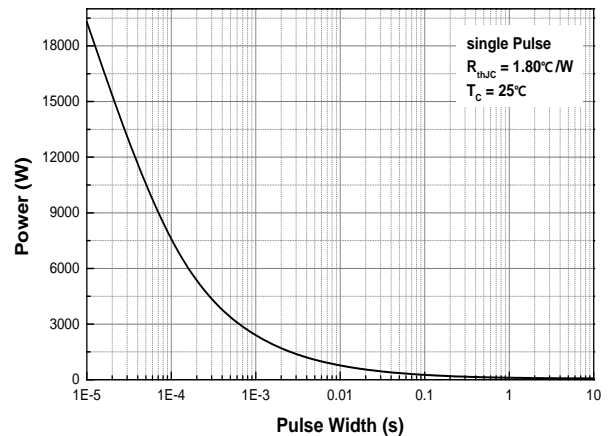
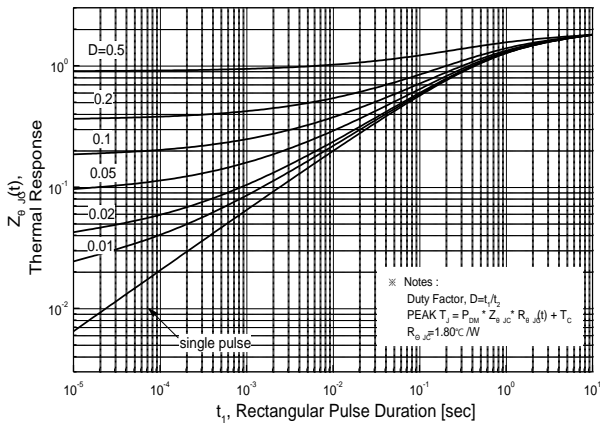
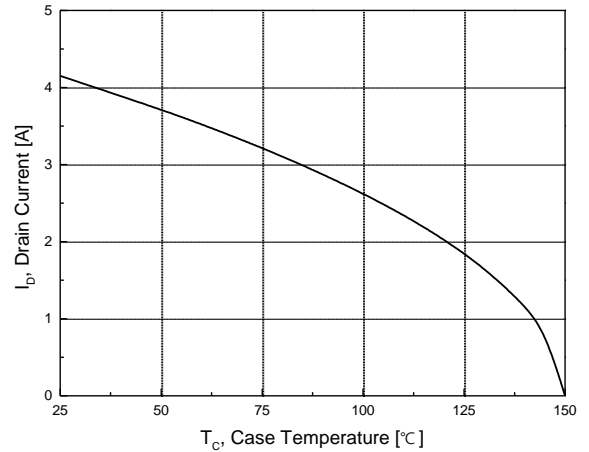
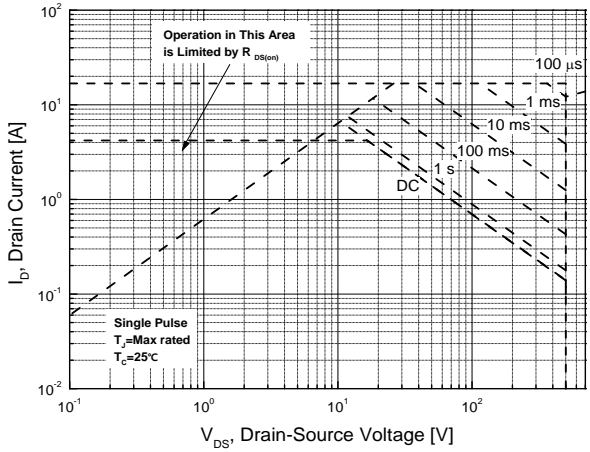
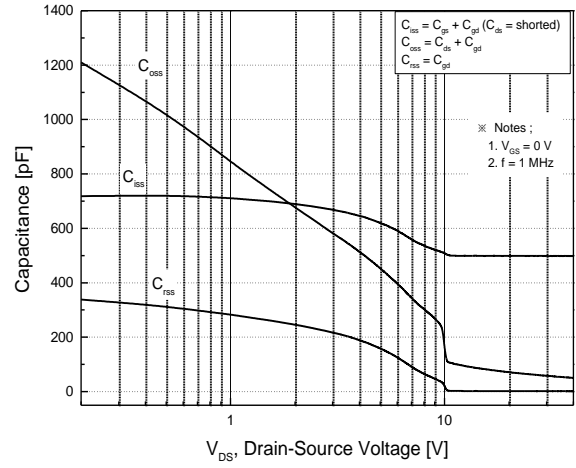
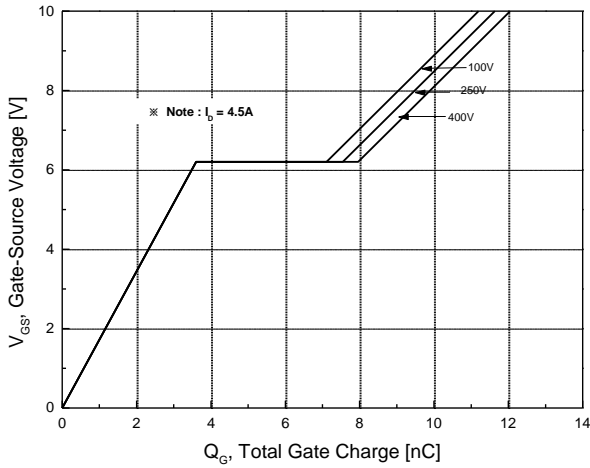


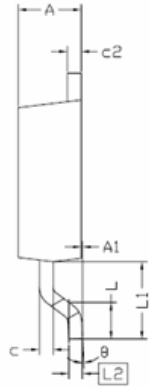
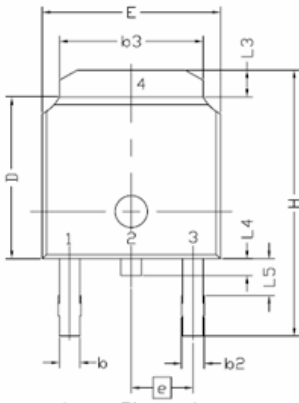
Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature



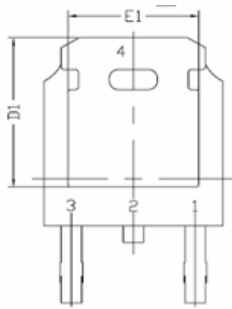
Package Dimension

TO-252

Dimensions are in millimeters, unless otherwise specified




Symbol	Min.	Nom.	Max.
E	6,35	-	6,73
L	1,40	1,52	1,78
L1	2,74 REF		
L2	0,508 BCS		
L3	0,89	-	1,27
L4	-	-	1,02
L5	1,14	-	1,52
D	5,97	6,10	6,22
H	9,40	-	10,41
b	0,64	-	0,89
b2	0,76	-	1,14
b3	4,95	-	5,46
e	2,286 BCS		
A	2,18	-	2,39
A1	-	-	0,13
c	0,46	-	0,61
c2	0,46	-	0,89
D1	5,21	-	-
E1	4,32	-	-
⌀	0,00	-	10,00



DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

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